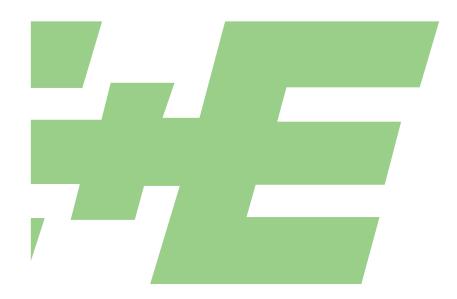


# **TECHNICAL USER GUIDE**



# CO<sub>2</sub> Module EE894 Protocol Description I<sup>2</sup>C





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## 1 Introduction

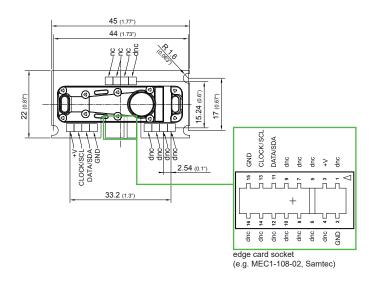
EE894 supports the standard I<sup>2</sup>C specification. For details please see NXP UM10204 "I<sup>2</sup>C-bus specification and user manual", Rev. 6, 4 April 2014; <a href="https://www.nxp.com/docs/en/user-quide/UM10204.pdf">https://www.nxp.com/docs/en/user-quide/UM10204.pdf</a>.

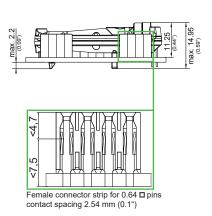
#### **Disclaimer**

The manufacturer or his authorized agent can be only be held liable in case of willful or gross negligence. In any case, the scope of liability is limited to the corresponding amount of the order issued to the manufacturer. The manufacturer assumes no liability for damages incurred due to failure to comply with the applicable regulations, operating instructions or the operating conditions. Consequential damages are excluded from the liability.

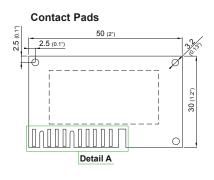
## 2 Hardware

## 2.1 Connection Diagram EE894 Compact



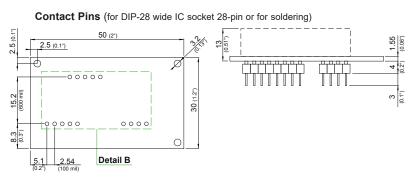


## 2.2 Connection Diagram EE894 Standard

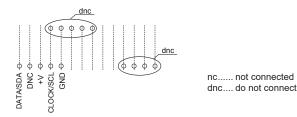


2.54 (100 mil) 1.25 (52mil) 1.26 (50 mil) 1.

Detail A / Connection Diagram:



Detail B / Connection Diagram:



## 2.3 Setup

Connection scheme for EE894 with connected bus-high-voltage via two external pull-up resistors.

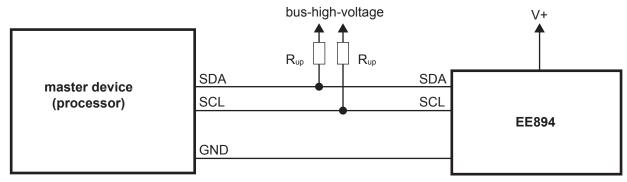


Fig. 1 Hardware master / slave setup

#### Note:

Observe the compatibility of the voltage levels between the  $I^2C$  Interface levels and the master processor.

## **Electrical requirements**

Parameter	Minimum	Maximum	Unit	Remark
bus-high-voltage	3.3	5.2	V	
clock frequency	500	100000	Hz	The highest achievable data rate depends on the combination
pull-up resistor	4.7	100	kΩ	of line capacity and the pull-up resistors.

## 2.4 Timing Details

	Minimum	Typical	Maximum
t <sub>pwrup</sub> * (power up)	4.7 s		16.2 s
t <sub>meas</sub> (measurement)		0.8 s	
t <sub>mti</sub> (measurement time interval) ± 6.25%	15 s		3 600 s

<sup>\*</sup> see chapter 2.5

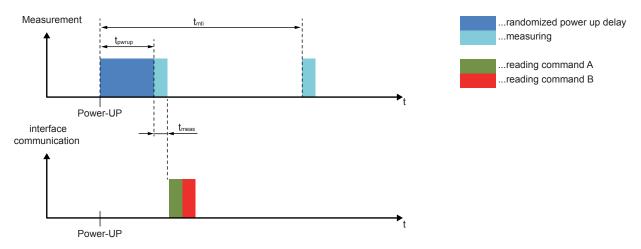


Fig. 2 Timing example

## 2.5 Power Consumption Details

EE894 module is designed to change its operation mode based on the actual status of measurement or communication. The supply current is different for each operation mode and it is shown given below as well as in Figure 3.

Mode	Supply current	Description
Sleep mode	typ. 410 μA	The module is waiting for measurement or communication request
Warm-up mode	typ. 10 mA	The module is in warm-up mode. Duration 450 ms before a measurement is taken.
Communication mode	typ. 10 mA	Initiated by an interrupt on the I <sup>2</sup> C Bus and lasts as long as the communication is ongoing
Measuring mode	max. 350 mA	current peak, caused by flashing the infrared lamp. For details see Figure 2.

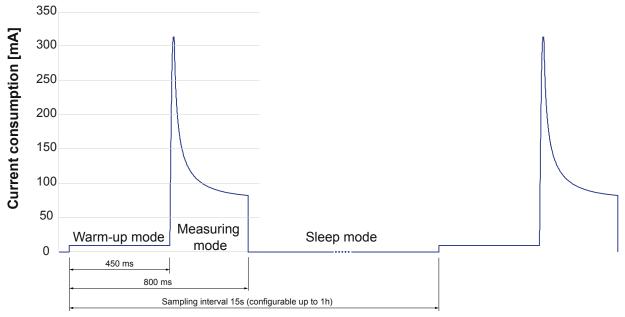


Fig. 3 Power consumption

Setting a longer measuring interval extends the sleep mode time.

After a reset the module starts the first measurement after 5 s to 15 s; the timing  $(t_{pwrup})$  is defined by a randomizer and is specific for each EE894. The randomizer is constant for each power up but varies from module to module.

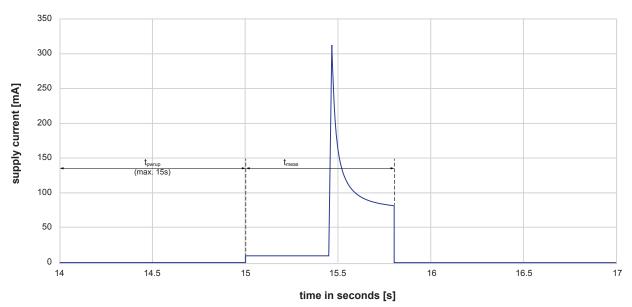


Fig. 4 Supply current in measuring mode @ 23 °C

## 3 Interface Description

## 3.1 Protocol

The I<sup>2</sup>C interface of EE894 supports the "Standard-Mode" up to 100 kbit/s, 8-bit oriented, where the I<sup>2</sup>C slave address is 7 bit long. The master has to support clock streching (CS).

## 3.2 Addressing

The slave address is 0x33. Accordingly, the address byte 0x67 is used to read and 0x66 to write, please refer to the <u>NXP specs section 3.1.10</u>.

The I<sup>2</sup>C interface of the EE894 module supports reading the measured data as well as writing in the customer memory. List of supported commands:

## Reading command A: 0xE000

Read the temperature value in 0.01 Kelvin and relative humidity value in 0.01 %.

START	I <sup>2</sup> C ADDRESS - 0x66 (W)	CS ACK	CMD MSB - 0xE0 ACK CMD LSB - 0x00	ACK
S	0 1 1 0 0 1 1 0		1 1 1 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	

#### Reading command B: 0xE027

Read the averaged  $CO_2$  value in 1 ppm, the raw  $CO_2$  value in 1 ppm and ambient pressure in 0.1 mbar

START	I <sup>2</sup> C ADDRESS - 0x66 (W)	CS A	СК	CMD MSB - 0xE0	ACH	CMD LSB - 0x27 ACK	
s	0 1 1 0 0 1 1 0			1 1 1 0 0 0 0 0		0 0 1 0 0 1 1 1	

## Command for customer memory access: 0x7154

Command for measurement time configuration and customer adjustment

START	I <sup>2</sup> C ADDRESS - 0	x66 (W)	cs	ACK	CI	/ID MS	B - 0	X71	AC	СК	CM	ID LS	B - 0)	(54	AC	ĸ	М	EM A	ADR	ACK	
S	0 1 1 0 0 1	1 1 0			0 1	1 1	0 0	0 0	1	0	1	0   1	0 1	0 0			t bit bit		oit bit		
										•	•		•						•		•
																				4	
																				<b>—</b>	_
	DATA [0]	AC		• •		DA	TA [r	1]	ı	ACK		C	RC8		Α	АСК	STOP				_

## 3.3 Data Definition

- There are 16-bit unsigned integers in the form of 2 bytes each.
- The MSB (most significant byte) comes first, then the LSB (least significant byte).
- After each 2 data bytes, a CRC byte ("CRC8") is sent to ensure that the data has been transferred correctly. This CRC8 is calculated from the 2 data bytes.

Property	Value
Width	8 bit
Polynomial	0x31(x8 + x5 + x4 + 1)
XOR input	0xFF
Reflect input	False
Reflect output	False
XOR output	0x00

- If the data readout is cancelled (e.g., after "CO<sub>2</sub> average value") then the rest of the data will not be read
- Clock stretching is necessary to start the microcontroller and might occur before every ACK. I2C
  master clock stretching needs to be implemented according to the NXP NXP specs section 3.1.9. The
  boot-up time is < 500 ms.</li>

## 3.4 Example for CRC8 Calculation:

```
#define CRC8_ONEWIRE_POLY 0x31
#define CRC8_ONEWIRE_START 0xff
static unsigned char i2cCalcCRC8 (unsigned char buf[], unsigned char from, unsigned char to)
 unsigned char crcVal = CRC8_ONEWIRE_START;
 unsigned char i = 0;
 unsigned char j = 0;
 unsigned char curval = 0;
 for (i = from; i < to; i ++)
  int curVal = buf[i];
  for (j = 0; j < 8; j ++)
   if (((crcVal ^ curVal) & 0x80) != 0) // If MSBs are not equal
    crcVal = ((crcVal << 1) ^ CRC8_ONEWIRE_POLY);
   else {
    crcVal = (crcVal << 1);
   curVal = curVal << 1;
return crcVal;
```

## 3.5 Communication Flow for Measurement Results

The green marked content comes from the module, other commands are sent by the master. First, the EE894 needs to be initialized on which two commands shall be read.

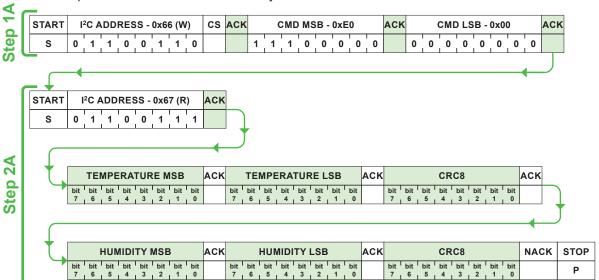
## 3.5.1 Reading Relative Humidity & Temperature - Command A: 0xE000

#### Step 1A:

Initialize command A or switch from command B to command A for reading the temperature and relative humidity data.

#### Step 2A:

Now the temperature and the relative humidity data can be read.



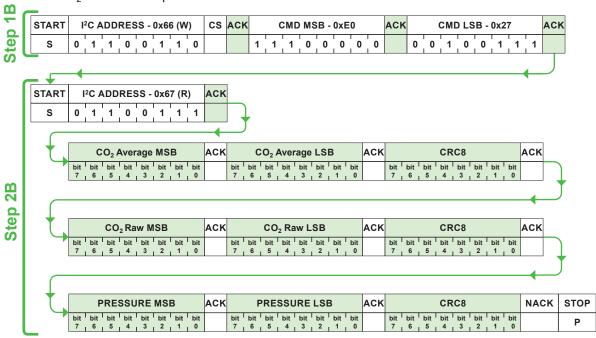
## 3.5.2 Reading CO<sub>2</sub> and ambient pressure - Command B: 0xE027

### Step 1B:

Initialize command B or switch from command A to command B for reading the CO<sub>2</sub> and the ambient pressure data

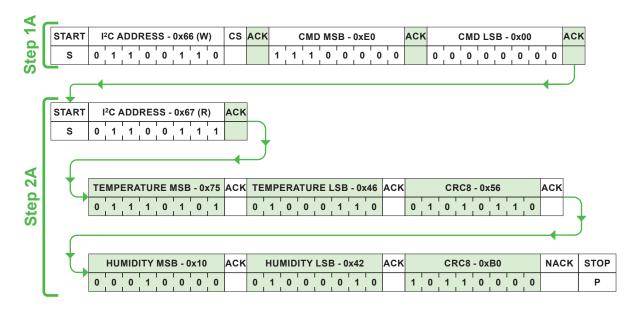
### Step 2B:

Now the CO<sub>2</sub> and ambient pressure data can be read:



## 3.6 Examples reading measurement results

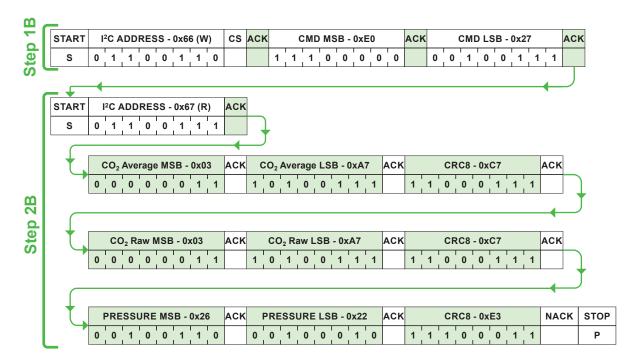
## 3.6.1 Reading Measurement Results RH/T - Command A: 0xE000



## Calculation of measuring values

- Temperature: MSB 0x75 LSB 0x46  $\rightarrow$  30022<sub>10</sub> (30022/100 273.15) = 27.07 °C
- Relative humidity: MSB 0x10 LSB 0x42  $\rightarrow$  4162<sub>10</sub> (4162/100) = 41.62 %RH

## 3.6.2 Reading Measurement Results CO<sub>2</sub>/p - Command B: 0xE027



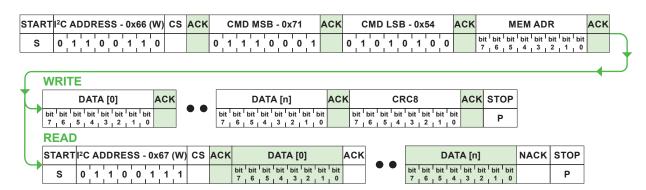
### Calculation of measuring values

• CO $_2$  average: MSB 0x03 LSB 0xA7  $\rightarrow$  935 $_{10}$  = 935 ppm • CO $_2$  raw: MSB 0x03 LSB 0xA7  $\rightarrow$  935 $_{10}$  = 935 ppm • Pressure: MSB 0x26 LSB 0x22  $\rightarrow$  9762 $_{10}$  (9762/10) = 976.2 mbar

# 4 Customer Memory Access

## 4.1 Main Command

Structure of command for customer memory access: 0x7154



The CRC8 checksum for writing into the customer memory is built out of the MEM ADR and the all DATA byte. This method for calculating the CRC8 works as protection of writing into the customer memory. As the module is processing the command after receive of the complete string, an incorrect CRC8 will also get confirmed by an ACK. Therefore it is recommended to read and compare the transmitted data.

## 4.2 Available Indexes

Index / MEM ADR	Function	Format	Unit	Comment
0 / 0x00	measurement time interval	2 byte	in 1/10 seconds	range 15 – 3600 seconds
1 / 0x01	CAM for relative humidity	4 (u)int16 values	in 1/100 %RH	offset = int16     gain = GainValue (uint16)/32768     lower limit = (uint16) level of last "lower" adjustment point     upper limit = (uint16) level of last "upper" adjustment point
2 / 0x02	CAM for temperature	4 (u)int16 values	in 1/100 K	offset = int16     gain = GainValue (uint16)/32768     lower limit = (uint16) level of last "lower" adjustment point     upper limit = (uint16) level of last "upper" adjustment point
3 / 0x03	CAM for pressure	4 (u)int16 values	in 1/10 mbar	offset = int16     gain = GainValue (unsigned int)/32768     lower limit = (uint16) level of last "lower" adjustment point     upper limit = (uint16) level of last "upper" adjustment point
4 / 0x04	CAM for CO <sub>2</sub>	4 (u)int16 values	in ppm	offset = int16     gain = GainValue (uint16)/32768     lower limit = (uint16) level of last "lower" adjustment point     upper limit = (uint16 level of last "upper" adjustment point
5 / 0x05	date for CAM relative humidity	3 byte	day/month/year	DD / MM / YY
6 / 0x06	date for CAM temperature	3 byte	day/month/year	DD / MM / YY
7 / 0x07	date for CAM pressure	3 byte	day/month/year	DD / MM / YY
8 / 0x08	date for CAM CO <sub>2</sub>	3 byte	day/month/year	DD / MM / YY
9 / 0x09	global date for CAM	3 byte	day/month/year	DD / MM / YY
10 / 0xA0	specific device name	16 byte	ASCII	all 16 byte must always be written, empty signs must be filled with 0x00

CAM...customer adjustment mode

## 4.3 Examples

• Change the measurement time interval to 20 seconds

Mes	ssa	age s	eg	men	it	Messa	age By	te	Conte	nt		
	S	STAR	Γ			S			START condition			
STEP 1	Α	ddre	ss			0x66			I <sup>2</sup> C addresse (write)			
	С	Comm	mand MSB			0x71			MSB customer memory		er memory	
	С	Comm	and	d LS	B	0x54			LSB c	ustome	r memory	
	In	ndex				0x00			index	for mea	surment time interval	
П		Щ					0x00	)x00		measurment time interval MSB		
Ш		WRITE	Da	ata			0xC8			meası	urment time interval LSB	
`		:P 2	Cł	neck	sum		0xB5			CRC	RC	
		STEP	ST	ГОР		Р				STOP	condition	
					START	-		S			START condition	
	9	Addres	ss		0x67			I <sup>2</sup> C adresse (read)				
			<b>→</b>	2 R	Dete			0x00			measurment time interval MSB	
				TEP	Data			0xC8			measurment time interval LSB	
			İ	Ś	STOP			Р			STOP condition	

## • Add an pressure offset of -22.2 mbar @ reference 1013,2 mbar

Mes	ssag	e s	egme	nt	Mess	age By	rte	Conte	ent		
	STA	\RT	Г		S			STAR	T cond	ition	
_	Add	lres	ss		0x66			I <sup>2</sup> C addresse (write)			
STEP	Cor	nm	and M	SB	0x71			MSB	custom	er memory	
ဟ	Command LSB Index				0x54			LSB	custome	er memory	
	Inde	ex			0x03			index	for pre	ssure	
						0xFF			offset	MSB	
						0x22			offset	LSB	
	ш					0x80			gain M	ISB	
	Data Data					0x00			gain L	SB	
IL						0x00			lower	wer limit MSB	
	֓֟֝֟֝֟֝֟֝֟֓֓֓֓֓֓֓֓֓֓֓֓֟֟֓֓֓֓֓֓֓֓֓֓֓֓֟֓֓֓֟֓֓֓֟֓֓֓֟֓֓֓֟֓֓֓֓	TEP 2 V				0x00			lower limit LSB		
	STEP			0x27			upper	limit MSB			
						0x94			upper	limit LSB	
			Check	sum		0xAF			CRC		
			STOP			Р			STOP	condition	
				START			S		START condition		
				Addres	s		0x67		I <sup>2</sup> C adresse (read)		
							0xFF			offset MSB	
			٥				0x22			offset LSB	
			READ				0x80			gain MSB	
			N .	Data			0x00			gain LSB	
			STEP	Data			0x00		Iower limit MSB		
			0)				0x00			lower limit LSB	
							0x27			upper limit MSB	
							0x94			upper limit LSB	
				STOP			Р			STOP condition	

## • Set date for CAM pressure to 24.12.2018

Me	es	sage	se	gme	ent	Mess	age By	rte	Cont	ent		
	1	STAR	Т			S			STAF	T cond	lition	
_	1	Addre	ss			0x66			I <sup>2</sup> C addresse (write)			
STEP	(	Comn	nan	d M	SB	0x71			MSB	custom	er memory	
က	Command LSB			0x54			LSB customer memory					
	I	Index				0x07			index	date fo	or pressure	
		Ш					0x18			day (2	24)	
		WRITE	Da	ıta			0x0C			month		
ľ	_	2 W					0x12			year (	18)	
		STEP	Ch	neck	sum		0x26	26		CRC		
		S	ST	ОР			Р			STOP	condition	
					START			s			START condition	
				AD	Address	3		0x67			I <sup>2</sup> C adresse (read)	
				RE,				0x18			day (24)	
Ī				<b>∃P</b> 2	Data			0x0C			month (12)	
				STEP				0x12			year (18)	
					STOP			Р			STOP condition	

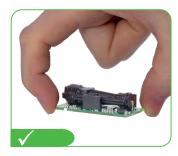
- Give the device the unique name: Best  ${\rm CO_2}$  sensor!

Message segment Message Byte				te	Conte	nt					
	START Address			S		STAR	START condition				
_				0x66		I²C addresse (write)					
STEP	Comn	nand I	MSB	0x71		MSB customer memory					
လ	Comn	nand L	_SB	0x54	0x54		LSB customer memory				
	Index			0xA0		index	index specific device name				
				0x42			B in A	ASCII			
					0x65			e in /	ASCII		
					0x73			s in A	ASCII		
					0x74			t in /	ASCII		
					0x00			_ in ASCII			
			)ata		0x43		C in ASCII				
					0x4F			O in ASCII			
		Data			0x32		2 in ASCII				
l	→ 2 WRITE	Data			0x00			_ in /	n ASCII		
	STEP 2				0x73			S in A	ASCII		
	ST				0x65			e in /	ASCII		
					0x6E			n in/			
					0x73			s in /	ASCII		
					0x6F			o in ASCII			
					0x72			r in ASCII			
					0x21			! in ASCII			
		-	hecksum		0x40			CRC			
		STO			P			STOP condition			
				START Address  Data		S 0x67 0x42 0x65 0x73 0x74 0x00 0x43 0x4F 0x32			START condition		
			Addres						I <sup>2</sup> C adresse (read)		
									B in ASCII		
									e in ASCII		
									s in ASCII		
									t in ASCII		
									in ASCII		
		AD							C in ASCII		
		2 READ							O in ASCII		
									2 in ASCII		
		STEP				0x00 0x73			in ASCII		
					0x65				S in ASCII		
									e in ASCII		
					0x6E				n in ASCII s in ASCII		
						0x73 0x6F			o in ASCII		
						0x6F 0x72 0x21			r in ASCII		
								! in ASCII			
			STOP			P			STOP condition		

# **5** Handling Instructions

- EE894 is an ESD sensitive device and shall be handled with corresponding precautions.
- EE894 and mainly the CO<sub>2</sub> sensing cell shall not be exposed to any mechanical stress during installation or operation. Mechanical stress on the sensing cell can lead to relevant measurement errors.
- For mounting EE894 with pins by soldering, the temperature at the EE894 module shall not exceed 60 °C (140 °F).

## 5.1 Handling and Mounting













### **Technical Data** 6

## **Measured values**

0	-	`	
C	l	J	٠

Measurement principle	Dual wavelength NDIR (non-dispersive infrared technology)					
Working range	02000 / 5000 / 10000 ppm					
Accuracy at 25 °C and 1013 mbar 1)	02000 ppm: < ± (50 ppm +2% of the measured value)					
(77 °F and 14.69 psi)	05000 ppm: < ± (50 ppm +3% of the measured value)					
	01% (010000 ppm): < ± (100 ppm +5% of the measured value)					
Response time t <sub>90</sub>	105 s with measured data averaging (smooth output)					
	60 s without measured data averaging					
Temperature dependency	typ. $\pm$ (1 + CO <sub>2</sub> concentration [ppm] / 1000) ppm/°C (-2045 °C) (-4113 °F) 0.014 % of the measured value / mbar (ref. to 1013 mbar) >5 years from 15 s (factory setup) up to 1 h; user selectable					
Pressure dependency						
Calibration interval 2)						
Sampling interval						
Relative humidity						
Working range	095 % RH (non condensing)					
Accuracy at 25 °C (77 °F)	typ. ± 3 % RH (2080 % RH)					
Pressure						
Working range	7001100 mbar (10.1515.95 psi)					
Accuracy at 25 °C (77 °F)	typ. ± 2 mbar (2080 % RH)					
Temperature dependency	± 0.015 mbar/K					
Temperature						
Working range	-4060 °C (-40140 °F)					
Accuracy at 25 °C (77 °F)	typ. ± 0.5 °C (± 0.9 °F)					
General						
Digital interface	I <sup>2</sup> C					
Supply voltage	4.75 - 7.5 V DC					
Average current 3)	420 μA (at 1 h sampling interval)					
at 25 °C (77 °F) and 5 V supply	3.2 mA (at 15 s sampling interval)					
Electrical connection	contact pins and edge card socket					
Working and storage conditions	-4060 °C (-40140 °F)					
	095 % RH (not condensating)					
	7001100 mbar (10.1515.95 psi)					
<del></del>						

With data averaging (smooth output) for averaging output.
 Recommended under normal operating conditions in building automation.
 The average current depends on the CO<sub>2</sub> sampling interval.





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